IGBT - Field Stop

600 V, 40 A

FGH40N60UFD

Description

Using novel Field Stop IGBT technology, ON Semiconductor's field stop IGBTs offer the optimum performance for solar inverter, UPS, welder, microwave oven, telecom, ESS and PFC applications where low conduction and switching losses are essential.

Features

- High Current Capability
- Low Saturation Voltage: $V_{CE(sat)} = 1.8 \text{ V} @ \text{ I}_{C} = 40 \text{ A}$
- High Input Impedance
- Fast Switching
- This Device is Pb-Free and is RoHS Compliant

Applications

• Solar Inverter, UPS, Welder, PFC, Microwave Oven, Telecom, ESS



ON Semiconductor®

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V _{CES}	Ι _C
600 V	40 A





TO-247-3LD CASE 340CK

MARKING DIAGRAM



ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

ABSOLUTE MAXIMUM RATINGS

Symbol	Description		Ratings	Unit	
V _{CES}	Collector to Emitter Voltage		600	V	
V _{GES}	Gate to Emitter Voltage		±20	V	
	Transient Gate-to-Emitter Voltage	Transient Gate-to-Emitter Voltage		V	
Ι _C	Collector Current T _C :	= 25°C	80	А	
	T _C =	= 100°C	40	А	
I _{CM} (Note 1)	Pulsed Collector Current T _C :	= 25°C	120	А	
PD	Maximum Power Dissipation T _C =	= 25°C	290	W	
	T _C =	= 100°C	116	W	
TJ	Operating Junction Temperature		-55 to +150	°C	
T _{STG}	Storage Temperature Range		-55 to +150	°C	
TL	Maximum Lead Temp. for Soldering Purposes, 1/8"	from Case for 5 Seconds	300	°C	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected. 1. Repetitive rating: Pulse width limited by max. junction temperature.

THERMAL CHARACTERISTICS

Symbol	Parameter	Тур.	Max.	Unit
$R_{\theta JC}$ (IGBT)	Thermal Resistance, Junction to Case	-	0.43	°C/W
$R_{\theta JC}$ (Diode)	Thermal Resistance, Junction to Case	-	1.45	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	-	40	°C/W

PACKAGE MARKING AND ORDERING INFORMATION

Part Number	Top Mark	Package	Packing Method	Reel Size	Tape Width	Qty per Tube
FGH40N60UFDTU	FGH40N60UFD	TO-247	Tube	N/A	N/A	30

ELECTRICAL CHARACTERISTICS OF THE IGBT (T_C = 25°C unless otherwise noted)

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
OFF CHARAC	TERISTICS	•	•			
BV _{CES}	Collector to Emitter Breakdown Voltage	V_{GE} = 0 V, I_{C} = 250 μ A	600	-	-	V
$\Delta BV_{CES} / \Delta T_{J}$	Temperature Coefficient of Breakdown Voltage	V _{GE} = 0 V, I _C = 250 μA	-	0.6	-	V/°C
I _{CES}	Collector Cut-Off Current	V _{CE} = V _{CES} , V _{GE} = 0 V	-	_	250	μA
I _{GES}	G-E Leakage Current	$V_{GE} = V_{GES}, V_{CE} = 0 V$	-	-	±400	nA
N CHARACT	ERISTICS					
V _{GE(th)}	G-E Threshold Voltage	I_C = 250 μ A, V_{CE} = V_{GE}	4.0	5.0	6.5	V
V _{CE(sat)} Collector to Emitter Saturation Voltage	I _C = 40 A, V _{GE} = 15 V,	_	1.8	2.4	V	
		I_{C} = 40 A, V_{GE} = 15 V, T_{C} = 125°C	-	2.0	-	v
YNAMIC CHA	ARACTERISTICS			.		
C _{ies}	Input Capacitance	V _{CE} = 30 V, V _{GE} = 0 V,	_	2110	_	pF
C _{oes}	Output Capacitance	f = 1 MHz	_	200	-	pF
C _{res}	Reverse Transfer Capacitance	-	-	60	-	pF
WITCHING C	HARACTERISTICS		•			
T _{d(on)}	Turn-On Delay Time	$V_{\rm CC} = 400 \text{ V}, I_{\rm C} = 40 \text{ A},$	-	24	-	ns
T _r	Rise Time	$R_G = 10 \Omega$, $V_{GE} = 15 V$, Inductive Load, $T_C = 25$ °C	-	44	-	ns
T _{d(off)}	Turn-Off Delay Time		-	112	-	ns
Τ _f	Fall Time		-	30	60	ns
Eon	Turn–On Switching Loss		-	1.19	-	mJ
E _{off}	Turn–Off Switching Loss		-	0.46	-	mJ
E _{ts}	Total Switching Loss		-	1.65	-	mJ
T _{d(on)}	Turn-On Delay Time	$V_{CC} = 400 \text{ V}, \text{ I}_{C} = 40 \text{ A},$	-	24	-	ns
T _r	Rise Time	$R_G = 10 \Omega$, $V_{GE} = 15 V$, Inductive Load, $T_C = 125$ °C	-	45	-	ns
T _{d(off)}	Turn-Off Delay Time		-	120	-	ns
Τ _f	Fall Time	1	-	40	-	ns
Eon	Turn–On Switching Loss	1	-	1.2	-	mJ
E _{off}	Turn-Off Switching Loss	-	-	0.69	-	mJ
E _{ts}	Total Switching Loss		-	1.89	-	mJ
Qg	Total Gate Charge	$V_{CE} = 400 \text{ V}, I_C = 40 \text{ A},$	-	120	-	nC
Q _{ge}	Gate to Emitter Charge	$V_{GE} = 15 V$	-	14	-	nC
Q _{gc}	Gate to Collector Charge	1	_	58	_	nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

Symbol	Parameter	Test Cor	nditions Min		Тур	Max	Unit
V _{FM}	Diode Forward Voltage	I _F = 20 A	$T_{C} = 25^{\circ}C$	-	1.95	2.6	V
			T _C = 125°C	-	1.85	-	
T _{rr}	Diode Reverse Recovery Time	I _F = 20 A, di _F /dt = 200 A/μs	$T_{C} = 25^{\circ}C$	-	45	-	ns
		αι _F /αι – 200 Α/μ3	T _C = 125°C	-	140	-	
Q _{rr}	Diode Reverse Recovery Charge]	$T_C = 25^{\circ}C$	-	75	-	nC
			$T_C = 125^{\circ}C$	-	375	-	

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

TYPICAL PERFORMANCE CHARACTERISTICS



Figure 1. Typical Output Characteristics



Figure 3. Typical Saturation Voltage Characteristics



Figure 5. Saturation Voltage vs. Case Temperature at Variant Current Level



Figure 2. Typical Output Characteristics



Figure 4. Transfer Characteristics



Figure 6. Saturation Voltage vs. V_{GE}

TYPICAL PERFORMANCE CHARACTERISTICS (Continued)



Figure 7. Saturation Voltage vs V_{GE}



Figure 9. Capacitance Characteristics





Figure 8. Saturation Voltage vs V_{GE}



Figure 10. Gate Charge Characteristics





TYPICAL PERFORMANCE CHARACTERISTICS (Continued)



vs. Gate Resistance



Figure 15. Turn-off Characteristics vs. Collector Current



Figure 17. Switching Loss vs. Collector Current





TYPICAL PERFORMANCE CHARACTERISTICS (Continued)





Rectangular Pulse Duration (sec)

Figure 23. Transient Thermal Impedance of IGBT





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